

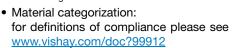
N-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	30			
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.0033			
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.0055			
Q _g typ. (nC)	9.5			
I _D (A) ^a	76.4			
Configuration	Single			

FEATURES

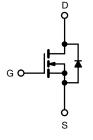
- TrenchFET® Gen IV power MOSFET
- 100 % R_g and UIS tested





APPLICATIONS

- High power density DC/DC
- Synchronous rectification
- Power conversion
- · Load switch



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiRA12CDP-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	30	v	
Gate-source voltage		V _{GS}	+20, -16		
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		76.4		
	T _C = 70 °C	l , 🗀	61.4		
	T _A = 25 °C	I _D	24.8 b, c		
	T _A = 70 °C		21.1 ^{b, c}	^	
Pulsed drain current (t = 100 μs)		I _{DM}	150	A	
Continuous source-drain diode current	T _C = 25 °C	,	31		
	T _A = 25 °C	I _S	3.3 b, c		
Single pulse avalanche current	L = 0.3 mH	I _{AS}	20		
Single pulse avalanche energy	L = 0.3 MH	E _{AS}	20	mJ	
Maximum power dissipation	T _C = 25 °C		34.7		
	T _C = 70 °C		22.2	w	
	T _A = 25 °C	P _D	3.6 b, c		
	T _A = 70 °C		2.3 b, c		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		
Soldering recommendations (peak temperature) d, e		Ü	260	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SMYBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, f	t ≤ 10 s	R _{thJA}	24	34	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	2.8	3.6]	

Notes

- a. Based on $T_C = 25 \,^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 70 °C/W

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				<u> </u>	l		
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V	
Drain-source breakdown voltage ^c (transient)	V _{DSt}	$V_{GS} = 0 \text{ V}, I_{D(aval)} = 20 \text{ A}, t_{transcient} \le 50 \text{ ns}$	34	-	-	٧	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	1 10 4	-	24	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 10 mA	-	-4.5	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.1	-	2.2	V	
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = +20, -16 V	-	-	± 100	nA	
Zero gate voltage drain current		V _{DS} = 30 V, V _{GS} = 0 V	-	-	1	_	
	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10	μA	
Duta a succession of the succe	5	V _{GS} = 10 V, I _D = 10 A	-	0.00265	0.0033	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	0.004	0.0055		
Forward transconductance a	9 _{fs}	V _{DS} = 10 V, I _D = 10 A	-	51	-	S	
Dynamic ^b	•			<u> </u>	I.		
Input capacitance	C _{iss}		-	1320	-	pF	
Output capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	525	-		
Reverse transfer capacitance	C _{rss}	1	-	35	-		
		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A	-	20	30		
Total gate charge	Q_g		-	9.3	14	nC	
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	4.5	-		
Gate-drain charge	Q _{gd}		-	2.3	-		
Output charge	Q _{oss}	V _{DS} = 15 V, V _{GS} = 0 V	-	14.5	-		
Gate resistance	Rg	f = 1 MHz	1.2	2.2	3.8	Ω	
Turn-on delay time	t _{d(on)}		-	9	18	-	
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_L = 1.5 \Omega$	-	4.5	9		
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	22	44		
Fall time	t _f		-	5	10		
Turn-on delay time	t _{d(on)}		-	19	38	ns	
Rise time	t _r	$V_{DD} = 15 \text{ V}, R_1 = 1.5 \Omega$	-	53	106	1	
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	27	54		
Fall time	t _f		-	12	25		
Drain-Source Body Diode Characteristi	cs						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	31	^	
Pulse diode forward current ^a	I _{SM}	-		-	150	A	
Body diode voltage	V_{SD}	I _S = 5 A	-	0.75	1.1	V	
Body diode reverse recovery time	t _{rr}		-	22	44	ns	
Body diode reverse recovery charge	Q_{rr}	I _F = 5 A, di/dt = 100 A/μs,	-	9	18	nC	
Reverse recovery fall time	ta	T _J = 25 °C	-	11	-	ns	
Reverse recovery rise time	t _b	1	_	11	-		

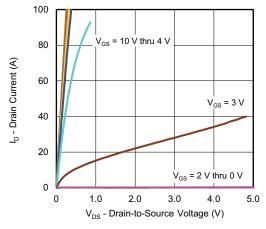
Notes

- a. Pulse test: pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Based on characterization, not subject to production testing

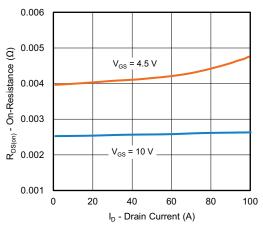
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



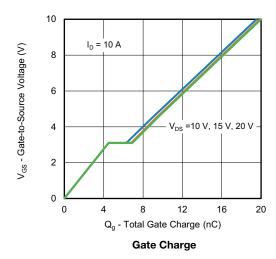
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

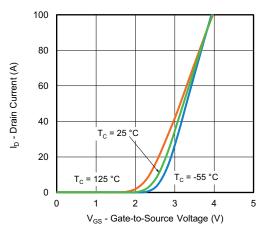


Output Characteristics

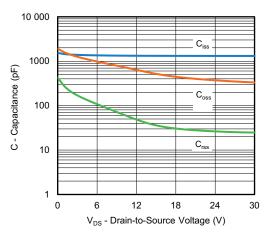


On-Resistance vs. Drain Current

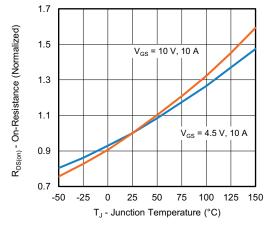




Transfer Characteristics



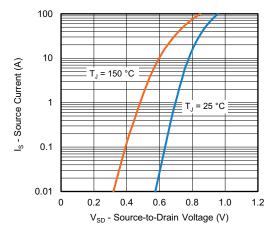
Capacitance



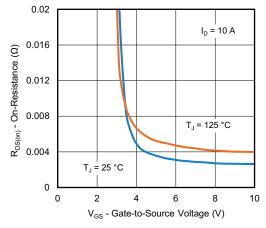
On-Resistance vs. Junction Temperature



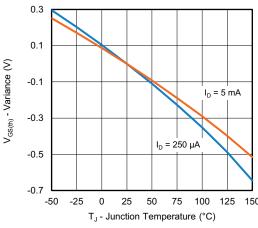
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



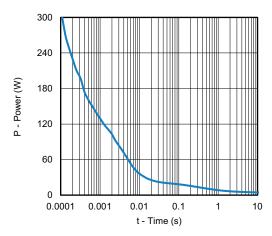
Source-Drain Diode Forward Voltage



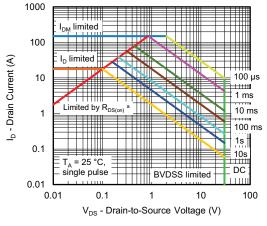
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



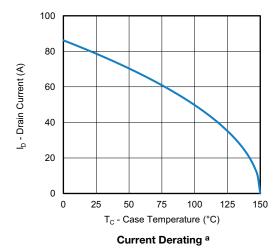
Safe Operating Area

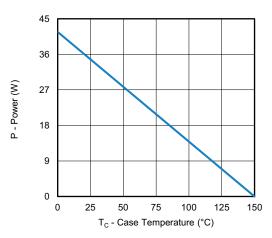
Note

a. $V_{GS} > minimum V_{GS}$ at which $R_{DS(on)}$ is specified

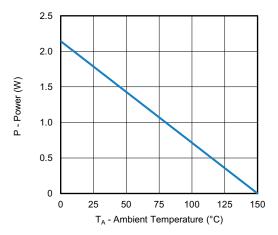
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Power, Junction-to-Case



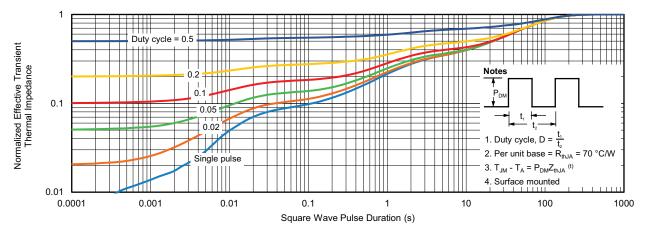
Power, Junction-to-Ambient

Note

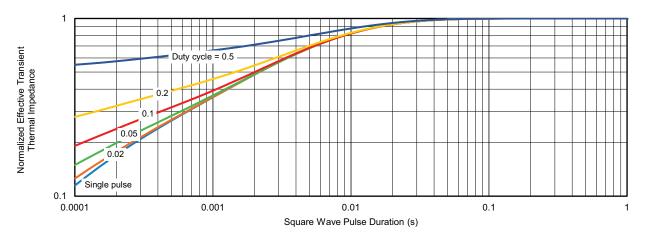
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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